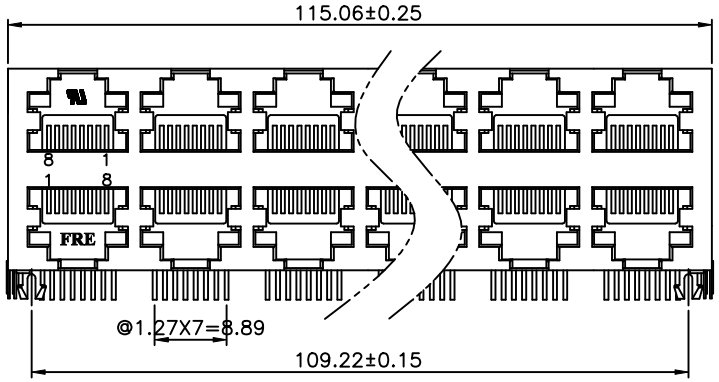
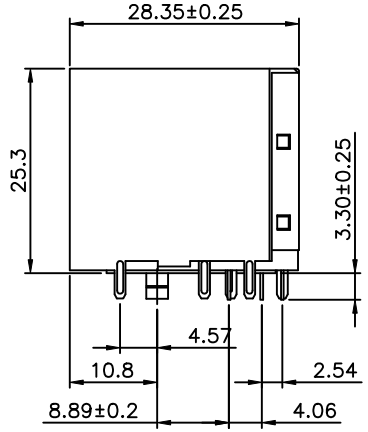
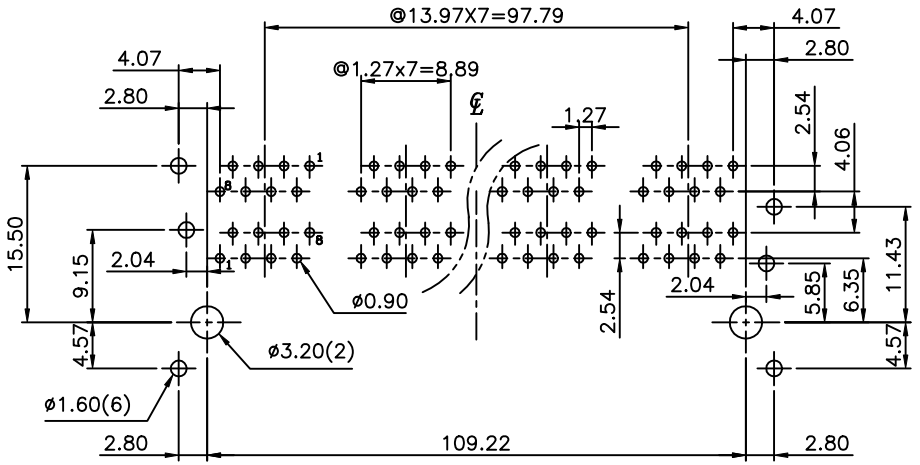
D1RFRD006

REVISION RECORD				
REV	ECO	DESCRIPTION	DRFT	CHKD







PC Board Layout
Component Side Shown

NOTES:

ELECTRICAL:
1. VOLTAGE RATING : 125 VAC RMS.
2. CURRENT RATING : 1.5 AMP.
3. CONTACT RESISTANCE : 50 MILLIOHMS MAX.
4. INSULATION RESISTANCE: 1000 MEGOHMS MIN @ 500 VDC.
5. DIELECTRIC STRENGTH : 1000 VAC RMS 60Hz, 1MIN.

MECHANICAL:
1. HOUSING MATERIAL : NYLON+30%.G.F UL94V-0.
2. CONTACT MATERIAL : PHOSPHOR BRONZE ø0.46mm.
3. PLATING : GOLD PLATING OVER NICKEL.
4. OPERATING LIFE : 750 CYCLES MIN.
5. PCB RETENTION PRE-SOLDER : 1 LB MIN.
6. PCB RETENTION POST-SOLDER: 10 LBS MIN.

ENVIRONMENTAL:
1. STORAGE : -40°C TO +85°C.
2. OPERATION: 0°C TO 70°C.
3. WAVE SOLDERING PEMPERRATURE:255°C~265°C(5~10 SECONDS)

MATES WITH MODULAR PLUG CONFORMING TO FCC PART 68, SUBPART F.

ROHS PART NUMBER: E5908-1XG13X-L

Shield:
1- Tin
7- Nickel

Gold Thickness:
1- 3u" 2- 6u" 3-15u"
4-30u" 5-50u"

MM (INCH)	DFTO JAMY	DATE 9/13/'05	FULL RISE ELECTRONIC CO., LTD
TOLERANCES EXCEPT AS NOTED	CHKD SAMMY	DATE 2005/09/14	
MM .0 ±0.10 ± .00 ±0.05 ± .000 ±0.005 ±	MFO	DATE	TITLE STACKED GANGED JACK,2X8
	APPVL LUSHENG	DATE 2005/09/14	
ANGLES ± 0.01°	MATERIAL :		DRAWING NO. GE593B04-LA SIZE A3 REV 0
THIRD ANGLE PROJECTION	QT'Y :		/PART NO. SEE NOTE
DETACHED LISTS	FINISH :		DO NOT SCALE DRAWING SHEET X OF Y
	SCALE : 2:1		

8 7 6 5 4 3 2 1

H G F E D C B A